

C-415102

04-11-2002

843.40547X00

Form PTO-1595

(Rev. 03/01)

OMB No. 0651-0027

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TSUCHIYAMA, HIROFUMI
KENBO, YUKIO
KATSUMURA, YOSHITERUAdditional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: HITACHI, LTD.Street Address: 6, Kanda Surugadai 4-chome,
Chiyoda-ku, Tokyo Japan

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other _____Additional name(s) & address(es) attached? ☐ Yes ☒ NoExecution Date: July 31, 2001; August 3, 6, 2001.

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: July 31, 2001; Aug. 3, 6, 2001.

A. Patent Application No.(s)

U.S. Serial No. 09/934,561 filed Aug. 23, 2001

B. Patent Registration No.(s)

Additional number(s) attached ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Antonelli, Terry, Stout & Kraus, LLP

Internal Address:

1300 North Seventeenth Street
Suite 1800
Arlington, VA 22209
USA

City: _____ State: _____ Zip: _____

6. Total number of applications and patents involved 17. Total fee (37 CFR 3.41)..... \$40.00☒ Enclosed☐ Authorized to be charged to deposit account

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*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*William I. Solomon, Reg. No. 28,565April 5, 2002

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Signature

Date

Total number of pages including cover sheet, attachments, and document: 5Mail documents to be recorded with required cover sheet information to:
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Docket No.: 843.40547X00

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attached original documents or copy thereof.

1. Name of conveying party(ies):

Shinichi NAKABAYASHI, Hisahiko ABE,
Hirofumi TSUCHIYAMA, Yukio KENBO,
and Toshiteru KATSUMURA

08/23/01

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: Hitachi, Ltd.

Street Address: 6, Kanda Surugadai 4-chome, Chiyoda-ku

City: Tokyo

Country: Japan

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: July 31, August 6, 6, 6, 3, 2001

4. Application number(s) or patent number(s):

09/934561

If this document is being filed together with a new application, the execution date of the application is: July 31, August 6, 6, 6, 3, 2001

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: ANTONELLI, TERRY, STOUT & KRAUS, LLP

Internal Address:

Street Address: 1300 North Seventeenth Street
Suite 1800

City: Arlington State: VA Zip: 22209

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$40.00

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Carl I. Brundidge

Name of Person Signing

Attorney Registration No. 29,621

Total number of pages including cover sheet, attachments, and document: 2

Signature

August 23, 2001

Date

OMB No. 0651-0011 (exp. 4/94)

11046 U.S. PTO
09/934561
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ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

METHOD OF MANUFACTURING SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

(発明者フルネームサイン)

Date Signed

(署名日)

1) <u>Shinichi Nakabayashi</u>	Shinichi NAKABAYASHI	<u>31/July/2001</u>
2) <u>Hisahiko Abe</u>	Hisahiko ABE	<u>6/AUG/2001</u>
3) <u>Hirofumi Tsuchiyama</u>	Hirofumi TSUCHIYAMA	<u>6/AUG/2001</u>
4) <u>Yukio Kenbo</u>	Yukio KENBO	<u>6/AUG/2001</u>
5) <u>Yoshiteru Katsumura</u>	Yoshiteru KATSUMURA	<u>3/Aug/2001</u>